



Description

The DIODES[™] DGD0504 is a high-voltage, high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half-bridge configuration. High-voltage processing techniques enable the DGD0504's high-side to switch to 100V in a bootstrap operation.

The DGD0504 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. DGD0504 has a fixed internal deadtime of 430ns (typical).

The DGD0504 is offered in the W-DFN3030-10 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

Applications

- DC-DC converters
- DC-AC inverters
- AC-DC power supplies
- Motor controls
- Class D power amplifiers



Typical Configuration

100V HALF-BRIDGE GATE DRIVER IN W-DFN3030-10

Features

- Floating High-Side Driver in Bootstrap Operation to 100V
- Drives Two N-Channel MOSFETs or IGBTs in a Half-Bridge Configuration
- 290mA Source/600mA Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Internal Dead Time of 430ns to Protect MOSFETs
- Wide Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for Vcc (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: W-DFN3030-10
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Finish Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.017 grams (Approximate)



Top View

Bottom View

W-DFN3030-10 (Type TH)

Ordering Information (Note 4)

Port Number	Part Number Package Marking Reel Size (inches)		Real Size (inches)	Tape Width (mm)	Packing	
Fart Number			Tape width (mm)	Qty.	Carrier	
DGD0504FN-7	W-DFN3030-10 (Type TH)	DGD0504	7	8	3,000	Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:

YYWW DGD0504 + DGD0504 = Product Type Marking Code YY = Year (ex: 22 = 2022) WW = Week (01 to 53)

Lead-free. 2. Hologon, and Antimony free "Creen" products are defined as these which contain z_{000} mm braming z_{000} mm oblaring (z1500 mm total Pr + Cl) and



Pin Diagrams



Pin Descriptions

Pin Number	Pin Name	Function
1	Vcc	Logic and Low-Side Supply
2	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
3	SD*	Logic Input for Shutdown, Enabled Low
4, 7	NC	No Connection (No Internal Connection)
5	COM	Low-Side and Logic Return
6	LO	Low-Side Gate Drive Output
8	Vs	High-Side Floating Supply Return
9	HO	High-Side Gate Drive Output
10	VB	High-Side Floating Supply
PAD	Substrate	Connect to COM on PCB

Functional Block Diagram





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +124	V
High-Side Floating Supply Offset Voltage	Vs	V _B – 24 to V _B + 0.3	V
High-Side Floating Output Voltage	Vно	Vs – 0.3 to V _B + 0.3	V
Offset Supply Voltage Transient	dVs/dt	50	V/ns
Low-Side Fixed Supply Voltage	Vcc	-0.3 to +24	V
Low-Side Output Voltage	VLO	-0.3 to Vcc + 0.3	V
Logic Input Voltage (IN and SD*)	Vin	-0.3 to Vcc + 0.3	V

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	64	°C/W
Thermal Resistance, Junction to Case (Note 5)	Rejc	42	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	TSTG	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	V _S + 10	V _S + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	100	V
High Side Floating Output Voltage	V _{HO}	Vs	VB	V
Low Side Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	Vlo	0	Vcc	V
Logic Input Voltage (IN and SD*)	Vin	0	5	V
Ambient Temperature	T _A	-40	+125	°C

Note: 6. Logic operation for V_S of -5V to +100V. Logic state held for V_S of -5V to -V_{BS}.



Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" (IN) & Logic "0" (SD*) Input Voltage	Vih	2.5	_	_	V	Vcc = 10V to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage	VIL	_	—	0.8	V	Vcc = 10V to 20V
High Level Output Voltage, Vыаs – Vo	Vон	_	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, Vo	Vol	_	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current	Ilk	_	—	50	μA	V _B = V _S = 100V
Quiescent V _{BS} Supply Current	IBSQ	_	60	100	μA	VIN = 0V or 5V
Quiescent Vcc Supply Current	lccq	_	350	500	μA	VIN = 0V or 5V
Logic "1" Input Bias Current	lin+	_	3.0	10	μA	VIN = 5V, SD* = 0V
Logic "0" Input Bias Current	lin-	_	—	5.0	μA	VIN = 0V, SD* = 5V
Vcc Supply Undervoltage Positive Going Threshold	Vccuv+	7.4	8.5	9.6	V	—
Vcc Supply Undervoltage Negative Going Threshold	Vccuv-	7.1	7.8	8.8	V	—
VBS Supply Undervoltage Positive Going Threshold	VBSUV+	5.5	6.5	7.5	V	—
VBS Supply Undervoltage Negative Going Threshold	VBSUV-	5.3	6.3	7.3	V	—
Output High Short Circuit Pulsed Current	lo+	130	290	_	mA	Vo = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	lo-	270	600	_	mA	Vo = 15V, PW ≤ 10µs

DC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, @TA = +25°C, unless otherwise specified.) (Note 7)

Note: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: IN and SD*. The V₀ and I₀ parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, CL = 1000pF, @TA = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton	—	680	820	ns	$V_{S} = 0V$
Turn-Off Propagation Delay	toff	—	150	220	ns	Vs = 100V
Shutdown Propagation Delay	tsp	—	160	220	ns	—
Delay Matching, HO and LO Turn-On/Turn-Off	tdм	—	_	60	ns	—
Turn-On Rise Time	tR	—	70	170	ns	Vs = 0V
Turn-Off Fall Time	t⊧	—	35	90	ns	Vs = 0V
Deadtime: tpт Lo-нo & tpт нo-Lo	tdт	300	430	550	ns	—



Timing Waveforms



Figure 1. Input / Output Timing Diagram



Figure 2. Shutdown Waveform Definition



Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)



Figure 4. Turn-on Propagation Delay vs. Supply Voltage



Figure 6. Turn-off Propagation Delay vs. Supply Voltage



800 700 Turn On Propagation Delay (ns) 600 500 400 ton High Side 300 ton Low Side 200 100 -40 -20 20 80 100 120 0 40 60 Temperature (°C)

Figure 5. Turn-on Propagation Delay vs. Temperature



Figure 7. Turn-off Propagation Delay vs. Temperature





Typical Performance Characteristics (continued)



Figure 10. Fall Time vs. Supply Voltage



Figure 12. Quiescent Current vs. Supply Voltage



Figure 14. Delay Matching vs. Supply Voltage











Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)



Figure 16. Output Source Current vs. Supply Voltage



Figure 18. Output Sink Current vs. Supply Voltage



Figure 20. Logic 1 Input Voltage vs. Supply Voltage



Figure 17. Output Source Current vs. Temperature





Figure 21. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (continued)



Figure 22. Logic 0 Input Voltage vs. Supply Voltage



Figure 24. Deadtime vs. Supply Voltage



Figure 26. VCC UVLO vs. Temperature







Figure 25. Deadtime vs. Temperature



Figure 27. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

W-DFN3030-10 (Type TH)



	W-DFN3030-10							
	(Type TH)							
Dim	Min Max Typ							
Α	0.70	0.80	0.75					
A1		0.05	0.02					
A3	0.18	0.25	0.20					
b	0.18	0.30	0.25					
D	2.90	3.10	3.00					
D2	2.40	2.60	2.50					
е	0.50BSC							
e1		2.00BS	SC					
E	2.90	3.10	3.00					
E2	1.45	1.65	1.55					
h	0.20	0.30	0.25					
L	0.30	0.50	0.40					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.500		
Х	0.300		
X1	2.300		
X2	2.600		
Y	0.600		
Y1	3.300		
Y2	1.650		

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.

W-DFN3030-10 (Type TH)



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